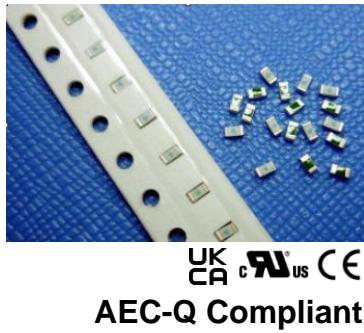


# Type C2F

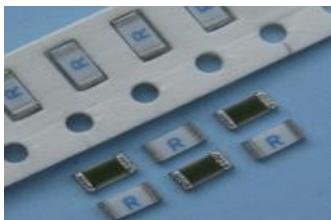
## Surface Mount Fast Acting Chip Fuse



### Typical Part Marking

Fuse body (ceramic white side)  
marked with marking code.

Example:



Current Rating	Marking Code	Current Rating	Marking Code
300mA	F	3A	3
500mA	J	3.5A	Z
750mA	M	4A	4
1A	1	5A	5
1.25A	P	6A	6
1.5A	R	7A	7
2A	2	8A	8
2.5A	T		

HF Pb C2F Series – 0603 Size

RoHS Compliant

### Features

- Fast Acting, with improved surge withstand performance
- Small size, 0603 SMD
- Current rating from 300mA to 8A, fuse marked with ampere code
- Wide operating temperature range from -55°C to 125°C
- Tape and Reel for automatic SMD placement
- Compatible with 260°C IR Pb-free and wave soldering process
- Full compliance with EU Directive 2011/65/EU and amending directive 2015/863 (MSL = 1)
- Halogen Free and Lead Free
- AEC-Q Compliant
- Meets Bel automotive qualification\*
- \* - Largely based on internal AEC-Q test plan

### Applications

- Notebook
- Automotive Navigation System
- LED Lighting
- Thin film transistor LCD flat-panel display screen
- PC computer
- Office electronic equipment
- Industrial equipment
- Medical equipment
- POE, POE+
- LCD / LED monitor and LCD / LED TV
- Power supply
- DC-DC Converter

LEAD FREE =



HALOGEN FREE



### Electrical Characteristics (UL STD. 248-14)

Testing Current	Blow Time	
	Minimum	Maximum
100%	4 Hrs.	N/A
200%	N/A	5 Sec
300%	N/A	0.2 Sec

### Safety Agency Approvals

Safety Agency	Safety Agency Certificate	Ampere Range/ Volt @ I.R. ability*	Ampere Range / Volt @ I.R. ability*
cUL us	E506667	300mA–8A/32V AC /63V DC	300mA–8A/35A@ 32V AC /50A@ 63V DC

\*I.R.= Interrupting Rating = Short Circuit Rating(Amps)

### Physical Specifications

Materials	Body : Ceramic Substrate
	Terminations : Ag / Ni / Sn (100% Lead-free)
	Element Cover Coating : Lead-free Glass
Marking	On Fuse :
	Marking Code
	On Label :
"bel", "C2F", "Current Rating", "Voltage Rating", "Interrupting Rating", "Appropriate Safety Logos" and "  ", "  "(China RoHS compliant).	



**bel**

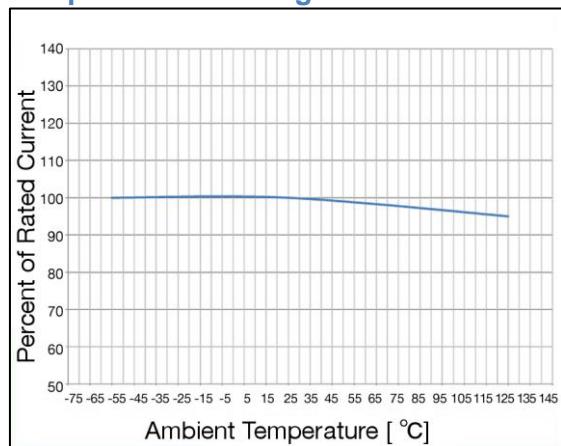
a bel group

POWER  
SOLUTIONS &  
PROTECTION

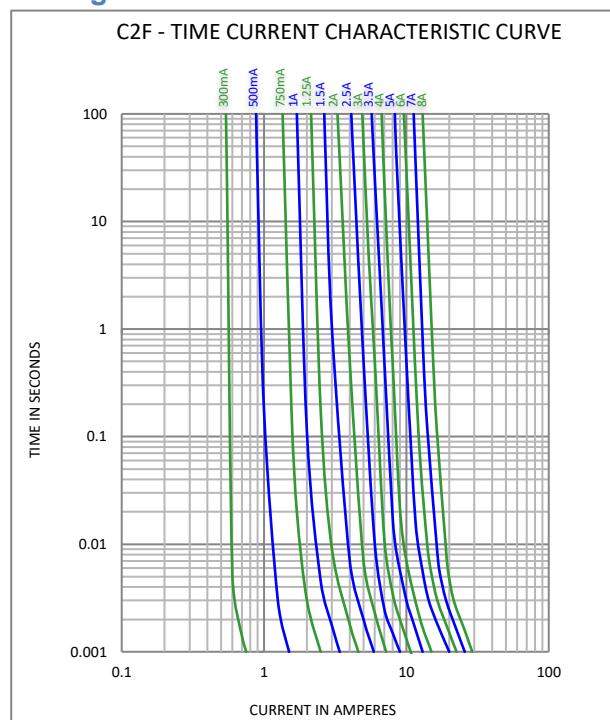
Specifications subject to change without notice

[belfuse.com/circuit-protection](http://belfuse.com/circuit-protection)

## Temperature Derating Curve



## Average Time Current Curve



## Electrical Specifications

Part Number	Ampere Rating (A)	Marking Code	Nominal Cold Resistance (ohms)	Maximum Volt-drop @100% In (Volt) max.	Voltage and Interrupting Ratings	Nominal Melting I <sup>2</sup> T @10 In (A <sup>2</sup> Sec)	Maximum Power Dissipation @100% In (W)	Agency Approvals
0686F0300-XX	300mA	F	0.720	0.315	See Table of Safety Approvals on Page 1 for Voltage and associated Interrupting Ratings	0.00004	0.09	Y
0686F0500-XX	500mA	J	0.430	0.310		0.0003	0.16	Y
0686F0750-XX	750mA	M	0.225	0.230		0.0013	0.17	Y
0686F1000-XX	1A	1	0.150	0.215		0.0028	0.22	Y
0686F1250-XX	1.25A	P	0.110	0.195		0.0045	0.24	Y
0686F1500-XX	1.5A	R	0.088	0.185		0.008	0.28	Y
0686F2000-XX	2A	2	0.060	0.180		0.014	0.36	Y
0686F2500-XX	2.5A	T	0.035	0.115		0.027	0.29	Y
0686F3000-XX	3A	3	0.026	0.110		0.040	0.33	Y
0686F3500-XX	3.5A	Z	0.021	0.103		0.058	0.36	Y
0686F4000-XX	4A	4	0.017	0.100		0.110	0.40	Y
0686F5000-XX	5A	5	0.0135	0.098		0.140	0.49	Y
0686F6000-XX	6A	6	0.0113	0.106		0.210	0.64	Y
0686F7000-XX	7A	7	0.0092	0.107		0.350	0.75	Y
0686F8000-XX	8A	8	0.0075	0.097		0.500	0.78	Y

Consult manufacturer for other ratings

## NOTES: Test Conditions

All test for ratings 300mA - 5A were conducted with fuse samples soldered on a PCB (1.6mm thick) test board with copper traces measuring 0.035 mm (35µm) nominal thickness (1 oz.clad), 5mm wide and 100 mm overall length.

All test for ratings 6A-8A were conducted with fuse samples soldered on a PCB (1.6mm thick) test board with copper traces measuring 0.070 mm (70µm) nominal thickness (2 oz. clad), 7.5mm wide and 100 mm overall length.

Device designed to be mounted with marking facing up.

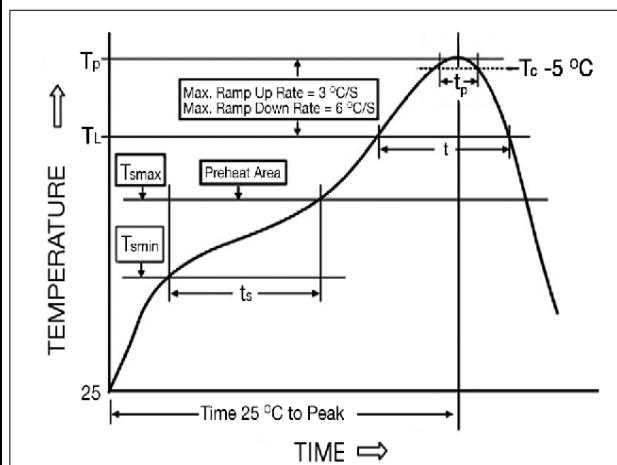
Device designed to carry rated current for 4 hours minimum. It is recommended that device be operated continuously at no more than 80% of rated current when in a +25°C ambient, with further derating at elevated ambient temperatures.

## Environmental Specifications

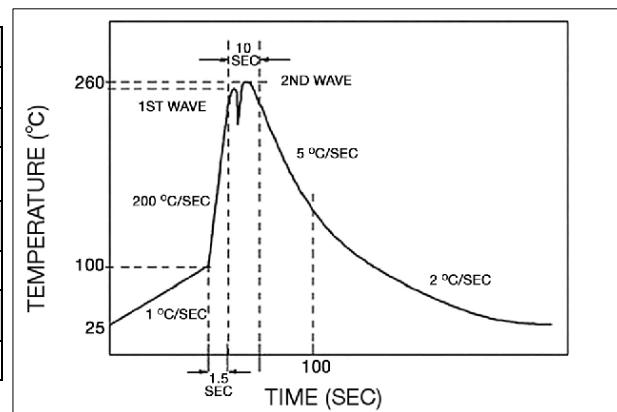
Shock Resistance	MIL-STD-202G, Method 213B, Test Condition 1 (100 G's peak for 6 milliseconds; Sawtooth waveform)	High temperature storage	MIL-STD-202 Method 108
Vibration Resistance	MIL-STD-202G, Method 201A (10-55 Hz, 0.06 inch, total excursion).	Temperature cycling	JESD22 Method JA-104,Test Condition B
Salt Spray Resistance	MIL-STD-202G, Method 101E, Test Condition B (48 hrs).	Biased humidity	MIL-STD-202 Method 103,85C/85% RH with 10% operating power for 1000 hrs
Insulation Resistance	MIL-STD-202G, Method 302, Test Condition A (After Opening) 10,000 ohms minimum.	Operational life	MIL-STD-202 Method 108, Test Condition D
Solderability	MIL-STD-202G, Method 208H	Resistance to solvents	MIL-STD-202 Method 215
Resistance to solder Heat	MIL-STD-202G, Method 210F, Test Condition C. Top Side(260°C,20 sec) MIL-STD-202G, Method 210F, Test Condition D. Bottom Side(260°C,10 sec)	Mechanical shock	MIL-STD-202 Method 213,Test Condition C
Thermal Shock	MIL-STD-202G, Method 107G, Test Condition B (-65°C to +125°C).	Vibration	MIL-STD-202 Method 204
Operating Temperature	-55°C to +125°C	Resistance to soldering heat	MIL-STD-202 Method 210,Test condition B
Moisture Sensitivity Level	1 (According to IPC J-Std-020)	Thermal shock	MIL-STD-202 Method 107
		Solderability	J-STD-002
		Board flex(SMD)	AEC-Q200-005
		Terminal strength	AEC-Q200-006
		Electrical characterization	3 temperature electrical

## Soldering Parameters

IR Reflow Profile (IPC/JEDEC J-STD-020D)	
<b>Preheat &amp; Soak</b>	
Temperature min (Tsmin)	150°C
Temperature max (Tsmax)	200°C
Time (Tsmin to Tsmax) (ts)	60-120 seconds
Average ramp-up rate (Tsmax to Tp)	3°C/second max.
Liquidous temperature (TL)	217°C
Time at liquidous (tL)	60-150 seconds
Peak temperature (Tp)	260°C max
Time (tp) within 5°C of the specified classification temperature (Tc)	30 seconds
Average ramp-down rate (Tp to Tsmax)	6°C/second max.
Time 25°C to peak temperature	8 minutes max.



Lead-free Wave Soldering Profile	
Wave Soldering Parameter	
Average ramp-up rate	200°C / second
Heating rate during preheat	typical 1 - 2°C / second Max 4°C / second
Final preheat temperature	within 125°C of soldering temperature
Peak temperature Tp	260°C
Time within +0°C / -5°C of actual peak temperature	10 seconds
Ramp-down rate	5°C / second max.



# Type C2F

4 / 4

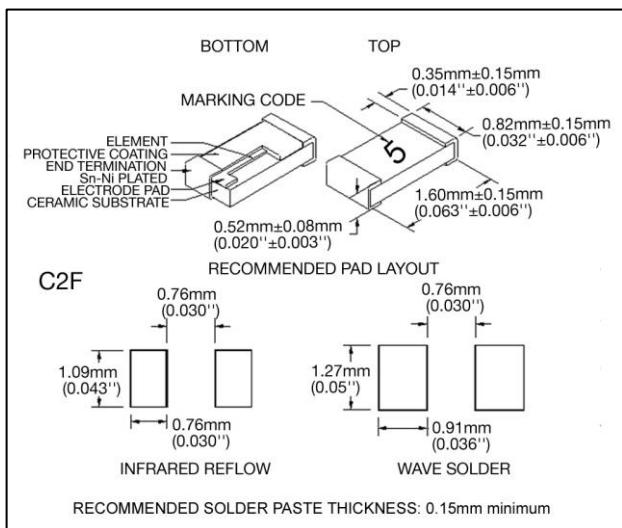
## Fuse FGNO Explanation

0686 F [XXXX] X XX

**0686F=C2F; [XXXX]=Ampere Rating; XX=See Ordering Information as below**

Fraction	Decimal	Amps	Bel FGNO[XXXX]
	1.0	1	1000
1-1/4	1.25	1.25	1250
1-1/2	1.50	1.5	1500
	2.0	2	2000
2-1/2	2.5	2.5	2500
	3.0	3	3000
3-1/2	3.5	3.5	3500
	4.0	4	4000
	5.0	5	5000
	6.0	6	6000
	7.0	7	7000
	8.0	8	8000

## Mechanical Dimensions



## Ordering Information

FUSE TYPE	 0686F <u>XXXX</u> - <u>XX</u>
0686F = C2F Series	
AMPERE RATING	<u>  </u>
Refer to fuse FGNO explanation table	
QUANTITY & PACKAGING CODE	<u>  </u>
01 = 5000 pcs with Tape and Reel	

## Packaging

Packaging Tape & Reel	Packaging Specification	Quantity	Quantity & Packaging Code
8 mm wide tape with 7 inches Diameter reel	EIA Standard 481-E	5000	0686FXXXX-01



Specifications subject to change without notice

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